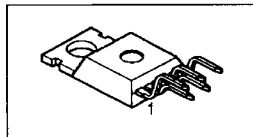


PROFET®

- High-side switch
- Short-circuit protection
- Overtemperature protection
- Overload protection
- Undervoltage and overvoltage shutdown with auto-restart and hysteresis
- Reverse battery protection
- Input and status protection
- Clamp of negative output voltage with inductive loads
- Protection against charged inductive load disconnect¹⁾
- Protection against loss of ground²⁾
- Open load detection in OFF-state
- Maximum current internally limited
- Status output for load fault
- R_{ON} constant versus V_{bb}
- Electrostatic Discharge (ESD) protection



Version differences see truth table and options overview, page 163...165

Package: TO220AB/5 (mounting flange is shorted to pin 3),
different package outlines (see page 168) on request

Ordering codes and packages see page 168

Pins				
1	2	3	4	5
GND	IN	V_{bb}	ST	OUT
-	I	+	S	O (Load, L)

Maximum Ratings

Parameter	Symbol	Values	Unit
Active overvoltage protection	$V_{bb(AZ)}$	> 50	V
Load current (Short-circuit current, see page 163)	I_L	self-limited	A
Operating temperature range	T_j	-40 ... +150	°C
Storage temperature range	T_{stg}	-55 ... +150	
Max. power dissipation	P_{tot}	125	W
Maximum current through input pin (DC)	I_{IN}	±2.0	mA
Maximum current through status pin (DC)	I_{ST}	±5.0	
see internal circuit diagram			
Thermal resistance	chip - case	R_{thJC}	1
	chip - ambient:	R_{thJA}	75
			K/W

¹⁾ with 150 Ω resistor in GND connection or freewheeling diode between V_{bb} and GND or freewheeling diode parallel to load. To protect against V_{bb} loss with an inductive load, it is recommended that a freewheeling diode be added between V_{bb} and GND.

²⁾ with additional external shottky diode between V_{bb} - and GND-pin

Electrical Characteristics

Parameter and Conditions at $T_j = 25^\circ\text{C}$, $V_{bb} = 12\text{V}$ unless otherwise specified	Symbol	Values			Unit
		min	typ	max	

Load Switching Capabilities and Characteristics

On-state resistance (pin 3 to 5) $I_L = 2\text{ A}$, $V_{IN} = \text{high}$	$T_j = 25^\circ\text{C}$: $T_j = 150^\circ\text{C}$:	R_{ON}	--	30 56	38 70	m Ω
Nominal load current (pin 3 to 5) ISO Proposal: $V_{bb} - V_{OUT} \leq 0.5\text{ V}$, $T_C = 85^\circ\text{C}$		$I_{L(ISO)}$	9	--	--	A
Open load detection current		$I_{L(OL)}$	--	30	--	μA
Open load detection voltage		$V_{OUT(OL)}$	--	3	--	V
Turn-on time Turn-off time	to 90% V_{OUT} to 10% V_{OUT}	t_{on} t_{off}	50 10	-- --	300 60	μs
$R_L = 12\ \Omega$						
Slew rate on 10 to 30% V_{OUT} , $R_L = 12\ \Omega$		dV/dt_{on}	--	--	2	V/ μs
Slew rate off 70 to 40% V_{OUT} , $R_L = 12\ \Omega$		$-dV/dt_{off}$	--	--	4	
Standby current (pin 3) $V_{IN} = 0$, $I_{ST} = 0$	$T_j = 150^\circ\text{C}$:	$I_{bb(off)}$	-- --	40 48	80 120	μA
Operating current (Pin 1), $V_{IN} = \text{high}$		I_{GND}	--	2.2 ³⁾	--	mA
Short circuit shutdown delay after input pos. slope $T_j = -40 \dots +150^\circ\text{C}$: $V_{bb} - V_{OUT} = V_{ON} > V_{ON(SC)}$ (see page 163) min value valid only, if input "low" time exceeds 60 μs		$t_d(SC)$	80	--	350	μs

Input and Status Feedback⁴⁾

Allowable input voltage range, (pin 2 to 1)	V_{IN}	-0.5	--	5.5	V
Input turn-on threshold voltage 	$V_{IN(T+)}$	1.5	--	2.4	V
Input turn-off threshold voltage 	$V_{IN(T-)}$	1.2	--	--	V
Input threshold hysteresis	$\Delta V_{IN(T)}$	--	0.5	--	V
Off state input current (pin 2) $V_{IN(off)} = 0.4\text{ V}$	$I_{IN(off)}$	1	--	30	μA
On state input current (pin 2) $V_{IN(on)} = 3.5\text{ V}$	$I_{IN(on)}$	10	25	70	
Delay time for status with open load (see timing diagrams, page 167)	$t_d(ST\ OL3)$		200		μs
Status valid after input slope (short circuit) $T_j = -40 \dots +150^\circ\text{C}$:	$t_d(ST)$	80	--	350	μs

³⁾ Add I_{ST} , if $I_{ST} > 0$ ⁴⁾ if a ground resistor R_{GND} is used, add the voltage across this resistor. Internal Z-diode typ. 6.1 V, see maximum ratings page 161, (see chapter 3)

Parameter and Conditions at $T_j = 25^\circ\text{C}$, $V_{bb} = 12\text{V}$ unless otherwise specified	Symbol	Values			Unit
		min	typ	max	
Status output (CMOS) $T_j = -40\dots+150^\circ\text{C}$, $I_{ST} = -50\text{ }\mu\text{A}$: $T_j = -40\dots+25^\circ\text{C}$, $I_{ST} = +1.6\text{ mA}$: $T_j = +150^\circ\text{C}$, $I_{ST} = +1.6\text{ mA}$:	$V_{ST(\text{high})}^{(6)}$ $V_{ST(\text{low})}$	4.4 -- --	5.1 -- --	6.5 0.8 1.0	V
Max. status current for valid status output, $T_j = -40\dots+150^\circ\text{C}$	current source (out): current sink (in) ⁵⁾ : $-I_{ST}$ $+I_{ST}$	-- --	-- --	0.25 1.6	mA

Operating and Clamp Voltages

Operating voltage $T_j = -40\dots+150^\circ\text{C}$:	$V_{bb(\text{on})}$	5.6	--	40	V
Undervoltage shutdown $T_j = 25\dots+150^\circ\text{C}$: $T_j = -40^\circ\text{C}$:	$V_{bb(\text{under})}$	2.0 2.0	-- --	4.8 5.2	
Undervoltage restart $T_j = 25\dots+150^\circ\text{C}$: $T_j = -40^\circ\text{C}$:	$V_{bb(\text{u rst})}$	-- --	-- --	4.9 5.6	
Overvoltage shutdown $T_j = -40\dots+150^\circ\text{C}$:	$V_{bb(\text{over})}$	42	--	52	
Overvoltage restart $T_j = -40\dots+150^\circ\text{C}$:	$V_{bb(\text{o rst})}$	40	--	--	
Overvoltage protection $T_j = -40\dots+150^\circ\text{C}$:	$V_{bb(\text{AZ})}$	50	56	--	
Load dump protection	$V_{bb(\text{LD})}$	--	--	93.5	
Output clamp (inductive load switch off)	$-V_{\text{OUT}(\text{CL})}$	--	16	--	
Short circuit shutdown detection voltage (pin 3 to 5)	$V_{\text{ON}(\text{SC})}$	--	8.6	10	

Protection Functions

Overload current limit (pin 3 to 5), after 50 ms, $V_{\text{ON}} = 8\text{ V}$, no heatsink ⁷⁾ , $T_j = -40\dots+150^\circ\text{C}$ version I:	$I_{\text{L}(\text{lim})}$	8.8	25.5	57	A
Thermal overload trip temperature	T_{jt}	150	--	--	$^\circ\text{C}$
Inductive load switch-off energy dissipation ⁸⁾ , $T_{\text{j start}} = 150^\circ\text{C}$, $V_{bb} = 12\text{ V}$: E_{Load12} $E_{\text{Load}} = \frac{1}{2} \cdot L \cdot I_{\text{L}}^2$ $V_{bb} = 24\text{ V}$: E_{Load24}	E_{ab} E_{Load12} E_{Load24}	-- -- --	-- -- --	1.7 0.4 -0.9	J
Reverse battery (pin 1 to 3) ⁹⁾	$-V_{bb}$	--	--	32	V

⁵⁾ no current sink capability during undervoltage shutdown

⁶⁾ $V_{\text{St high}} = V_{bb}$ during undervoltage shutdown

⁷⁾ this occurs, if circuit resistance is so high, that no short circuit shutdown occurs ($V_{\text{ON}} < V_{\text{ON}(\text{SC})}$)

⁸⁾ while demagnetizing load inductance, dissipated energy in PROFET is $E_{\text{ab}} = \int V_{bb(\text{AZ})} \cdot i_{\text{L}}(t) \cdot dt$.

⁹⁾ Reverse load current (through intrinsic drain-source diode) is normally limited by the connected load. Reverse current I_{GND} of about 0.4 A at $V_{bb} = -32\text{ V}$ through the logic (see chapter 3) heats up the device. Time allowed under these condition is dependent on the size of the heatsink. Input and Status currents have to be limited. is recommended that 15k Ω resistors be inserted in series with IN and ST.

Truth Table

	Input-level	Output level	Status
			version I1
Normal operation	L	L	H
	H	H	H
Open load	L	¹⁰⁾ H	L
	H	H	H
Short circuit to GND	L	L	H
	H	L	L
Short circuit to V _{bb}	L	H	L
	H	H	H
Overtemperature	L	L	L
	H	L	L
Under-voltage	L	L	L ¹¹⁾
	H	L	L ¹¹⁾
Overvoltage	L	L	L
	H	L	L

L = "Low" Level

H = "High" Level

¹⁰⁾ Power Transistor off, high impedance, versions BTS 432I1 internal pull up current source for open load detection.

¹¹⁾ no current sink capability during undervoltage shutdown

Options Overview

all versions: High-side switch, Input protection, ESD protection, load dump and reverse battery protection

Type	BTS	432I1
Logic version		I
Overtemperature protection $T_j > 150\text{ }^{\circ}\text{C}$, latch function ¹²⁾ $T_j > 150\text{ }^{\circ}\text{C}$, with auto-restart on cooling		X
Short-circuit to GND protection switches off when $V_{bb}-V_{OUT}>3.5\text{ V}$ typ. (when first turned on after approx. 150 μs) switches off when $V_{bb}-V_{OUT}>8.6\text{ V}$ typ. (when first turned on after approx. 150 μs) Achieved through overtemperature protection		X
Open load detection in OFF-state with sensing current 30 μA typ. in ON-state with sensing voltage drop across power transistor		X
Undervoltage shutdown with auto restart		X
Overvoltage shutdown with auto restart		X
Status feedback for overtemperature		X
short circuit to GND		X
short to V_{bb}		X
open load		X
undervoltage, overvoltage		X
Status output type CMOS		X
Open drain		
Output negative voltage transient limit (fast inductive load switch off)		X
Load current limit high level (can handle loads with high inrush currents) low level (better protection of application)		X

¹²⁾ Latch except when $V_{bb}-V_{OUT} < V_{ON(SC)}$ after shutdown. In most cases $V_{OUT}=0\text{ V}$ after shutdown ($V_{OUT} \neq 0\text{ V}$ only if forced externally). So the device remains latched unless $V_{bb} < V_{ON(SC)}$ (see page 163). No latch between turn on and $t_{d(SC)}$.

Timing diagrams

Figure 1a: V_{bb} turn on:

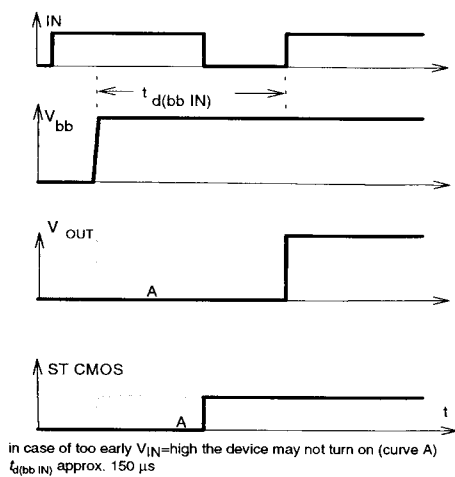


Figure 2a: Switching an inductive load:

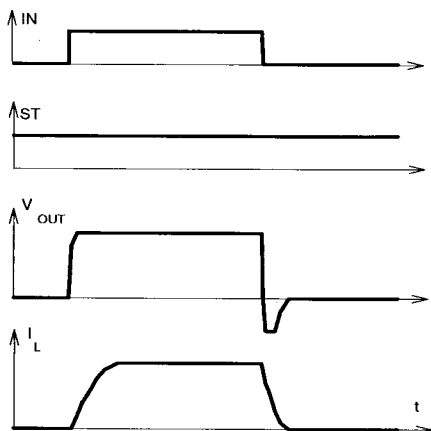


Figure 3a: turn on into short circuit,

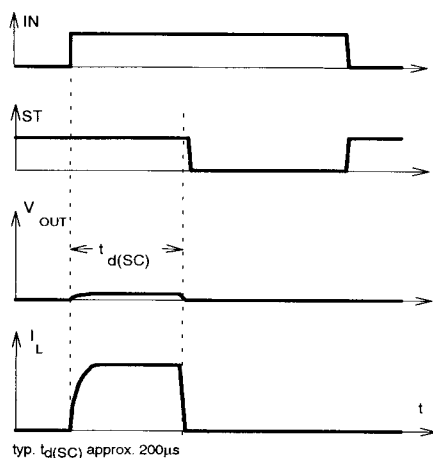


Figure 3b: short circuit while on:

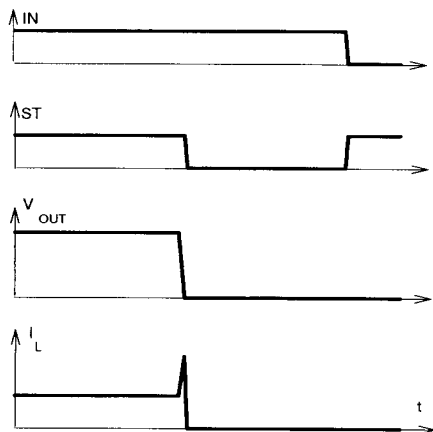


Figure 4a: overtemperature,
Reset if (IN=low) and ($T_J < T_{Jt}$)

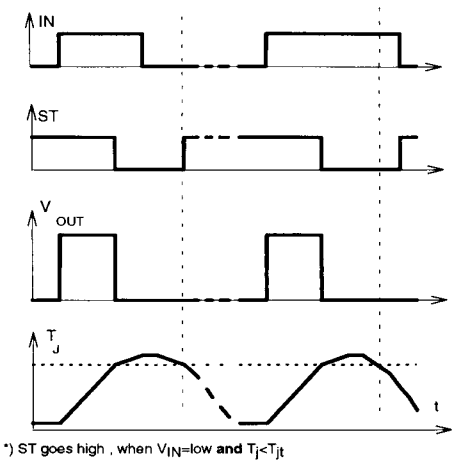


Figure 5a: open load: detection in OFF-state, turn on/off to open load

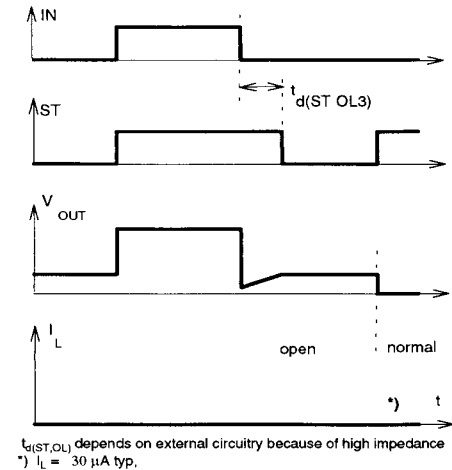
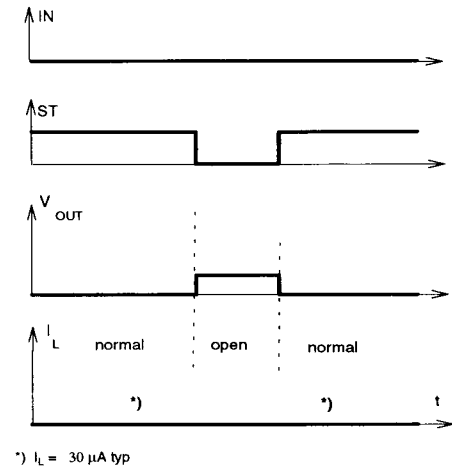
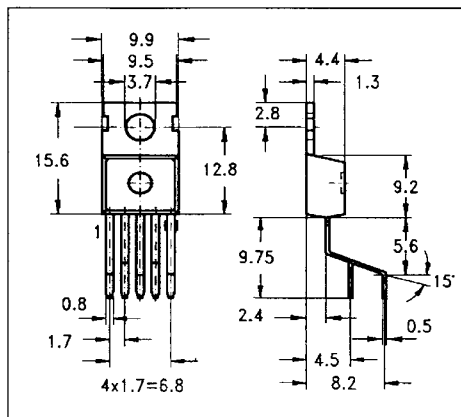


Figure 5b: open load: detection in OFF-state, open load occurs in off-state



Package and ordering code**Standard**

BTS 432 I1	C67078-S5308-A2
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**SMD**

BTS 432I1 E3122A	T&R: C67078-S5308-A3
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